

## MS49N60

### N-Channel 40V MOSFETs

#### Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

#### Features

- 40V, 150A,  $R_{DS(ON)} = 3.8m\Omega @ V_{GS} = 10V$
- Improved  $dv/dt$  capability
- Fast switching
- Green Device Available
- RoHS compliant package

#### Applications

- MB / VGA / Vcore
- POL Applications
- SMPS 2nd SR

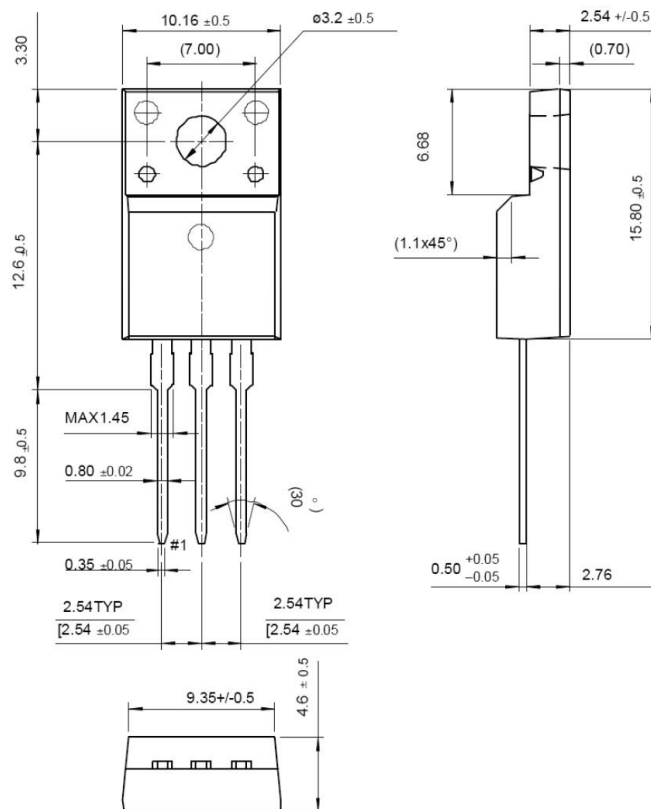
**Package type :** TO-220

#### Packing & Order Information

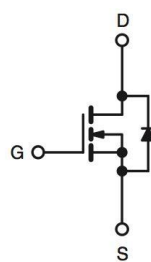
3,000/Box



**RoHS**  
COMPLIANT



#### Graphic symbol



### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

#### Absolute Maximum Ratings ( $T_A = 25^\circ C$ unless otherwise noted)

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-Source Voltage	40	V
$V_{GS}$	Gate-Source Voltage	±20	V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ C$ ) (Chip Limitation)	150	A
	Drain Current - Continuous ( $T_C = 100^\circ C$ ) (Chip Limitation)	83	A
$I_{DM}$	Drain Current - Pulsed <sup>1</sup>	400	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	312	mJ

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#### Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
I <sub>AS</sub>	Single Pulse Avalanched Current <sup>2</sup>	79	A
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> =25°C)	135	W
	Power Dissipation - Derate above 25°C	1.08	W/°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to +150	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to +150	°C

#### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
R <sub>θJA</sub>	Thermal Resistance Junction to ambient	--	62	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction to Case	--	0.92	

#### Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

##### Off Characteristics

Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250uA	40			V
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	BVDSS Temperature Coefficient	Reference to 25°C, I <sub>D</sub> =1mA		0.03		V/°C
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V			±100	nA
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 25°C V <sub>DS</sub> = 32 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125°C			1 10	uA

##### On Characteristics

Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
R <sub>DS(on)</sub>	Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 25 A V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 12 A		3.1 4.0	3.8 5.0	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	1.2	1.6	2.5	V
ΔV <sub>GS(th)</sub>	V <sub>GS(th)</sub> Temperature Coefficient	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA		-5		mV/°C
g <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 2 A		45		S

##### Dynamic and switching Characteristics

Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
t <sub>d(on)</sub>	Turn-On Delay Time <sup>3,4</sup>	I <sub>D</sub> = 1 A, R <sub>G</sub> = 6 Ω, V <sub>GS</sub> = 10 V, V <sub>DD</sub> = 20 V	--	28	50	ns
t <sub>r</sub>	Rise Time <sup>3,4</sup>		--	3.2	6.5	ns
t <sub>d(off)</sub>	Turn-Off Delay Time <sup>3,4</sup>		--	89	160	ns
t <sub>f</sub>	Fall Time <sup>3,4</sup>		--	14	28	ns

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Dynamic and switching Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
$Q_g$	Total Gate Charge <sup>3,4</sup>	$V_{DS} = 20\text{ V}$ , $I_D = 10\text{ A}$ , $V_{GS} = 4.5\text{ V}$	--	44.4	80	nC
$Q_{gs}$	Gate-Source Charge <sup>3,4</sup>		--	9.6	18	nC
$Q_{gd}$	Gate-Drain Charge <sup>3,4</sup>		--	16	30	nC
$C_{iss}$	Input Capacitance	$V_{DS} = 25\text{ V}$ $f = 1\text{ MHz}$ , $V_{GS} = 0\text{ V}$	--	4940	7800	pF
$C_{oss}$	Output Capacitance		--	425	800	pF
$C_{rss}$	Reverse Transfer Capacitance		--	170	330	pF
$R_g$	Total Gate Charge	$V_{DS} = 0\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GS} = 0\text{ V}$	--	1.4	2.8	$\Omega$

Drain-Source Diode Characteristics and Maximum Ratings						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
$I_S$	Continuous Source Current	$V_G = V_D = 0\text{ V}$ , Force Current	--	--	100	A
$I_{SM}$	Pulsed Source Current		--	--	200	A
$V_{SD}$	Diode Forward Voltage	$V_{GS} = 0\text{ V}$ , $I_S = 1\text{ A}$ , $T_J = 25^\circ\text{C}$	--	--	1	V

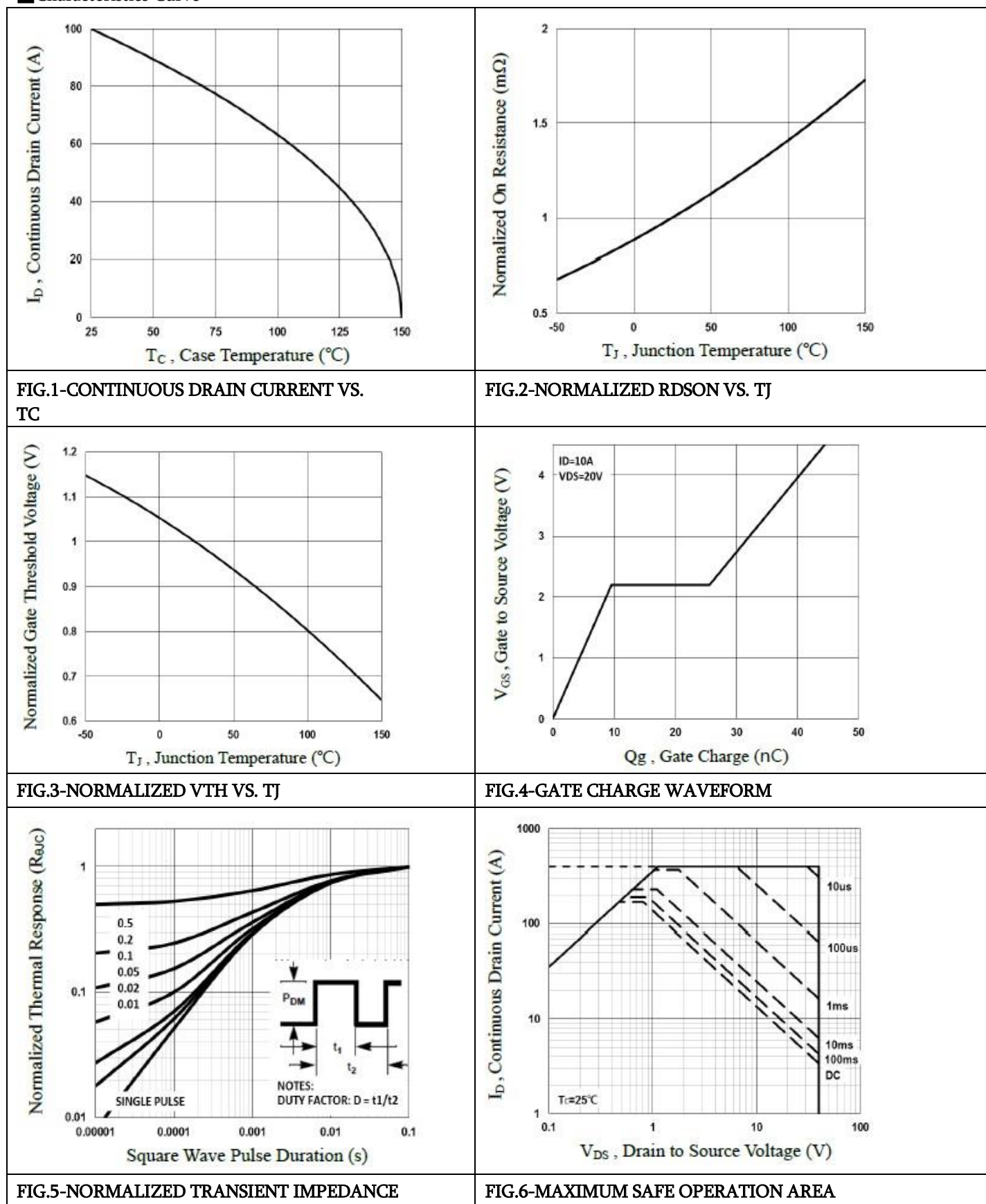
#### Note :

- 1.Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{DD}=25\text{V}$ ,  $V_{GS}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{AS}=79\text{A}$ ., Starting  $T_J=25^\circ\text{C}$
- 3.The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$ .
- 4.Essentially independent of operating temperature.

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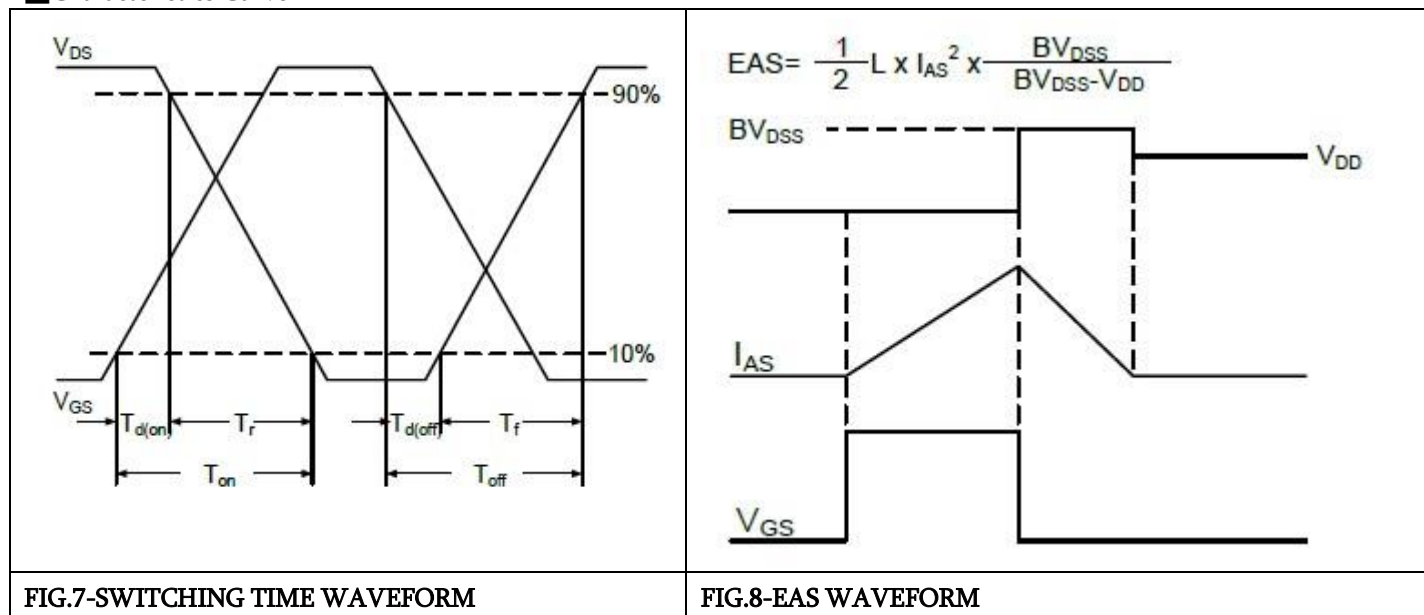
#### Characteristics Curve



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N-Channel 40V MOSFETs

### ■ Characteristics Curve



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